BCT4567
Low-Power, Dual SIM Card Analog Switch

GENERAL DESCRIPTION

The BCT4567 is a quad-SPDT switch with one common control inputs targeted at dual SIM

Pin Configurations
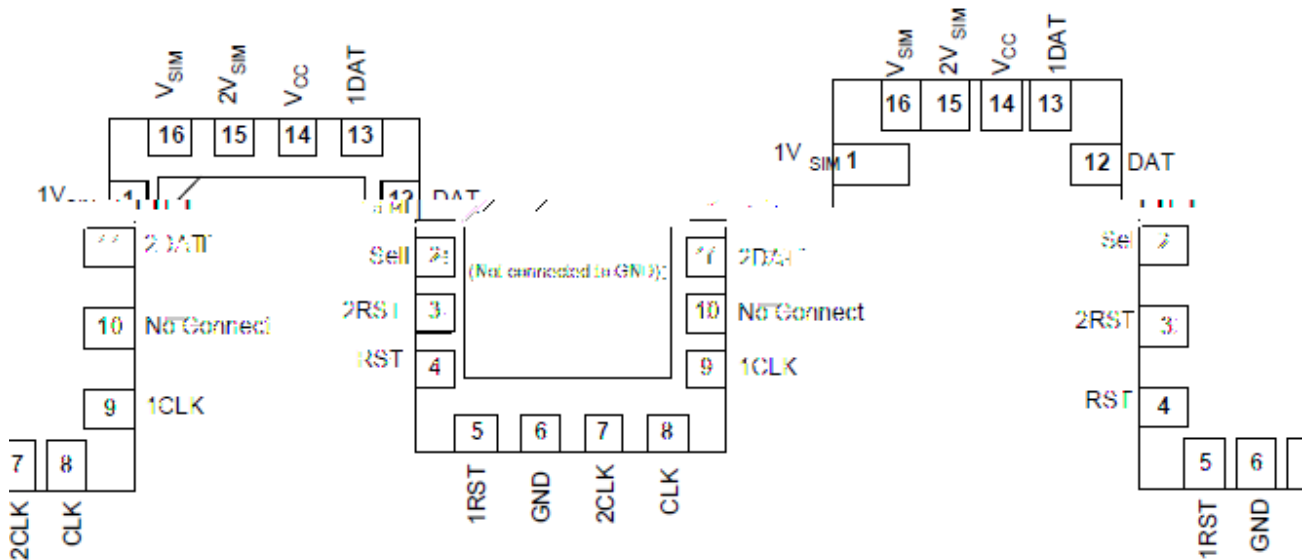
Pin Description

Pin	Name	Function
1	1VSIM	SIM supply output 2
2	SEL	Select input
3	2RST	RST Normally Open Terminal
4	RST	RST Common Terminal
5	1RST	RST Normally Closed Terminal
6	GND	Ground
7	2CLK	CLK Normally Open Terminal
8	CLK	CLK Common Terminal
9	1CLK	CLK Normally Closed Terminal
10	NC	Not Connect
11	2DAT	DAT Normally Open Terminal
12	DAT	DAT Common Terminal
13	1DAT	DAT Normally Closed Terminal
14	VCC	Power Supply
15	2VSIM	SIM supply output 1
16	VSIM	SIM supply input

Truth Table

SEL	SWITCH STATE
0	1DAT = DAT, 1RST = RST, 1CLK = CLK, $1V_{SIM} = V_{SIM}$
1	2DAT = DAT, 2RST = RST, 2CLK = CLK, $2V_{SIM} = V_{SIM}$

Absolute Maximum Ratings

V_{CC}, SEL to GND...-0.3V to +6.0V
All Other Pins to GND   ..   ..-0.3V to (VCC + 0.3V)
Continuous Current   .   .... ±400mA
Peak Current (pulsed at 1ms, 10% duty cycle)   .   ...±500mA
Continuous Power Dissipation (TA = +70°C) (15.6mW/°C above +70°C) 1.25W
Operating Temperature Range ....-40°C to +85°C
Storage Temperature Range...-65°C to +150°C
Junction 01(C)]TJETT BT1.0303 0 0 1 410.26 465462.55 Tm[ )]TJET EMC /P e1.99 Tm[01(C)]TJET.)6(TJET1(1)-a℄u2(O)(1)-3

REV1.

Electrical Characteristics (continued)

(unless otherwise noted. Typical values are at V_{CC} = 3.3V, T_A = +25°C.) [2]

Parameter	Symbol	Conditions		Min	Typ	Max	Units
DYNAMIC CHARACTERISTICS							
Turn-On Time Sel to Output (DAT,CLK,RST)	T_{ON}	Pf, VSW = 1.5 V, Figure 11, Figure 12	T_A = +25°C		20	30	ns
			T_A = T_{MIN} to T_{MAX}			50	
Turn-Off Time Sel to Output (DAT,CLK,RST)	T_{OFF}	pF, VSW = 1.5 V, Figure 11, Figure 12	T_A = +25°C		15	40	ns
			T_A = T_{MIN} to T_{MAX}			50	
Break-Before-Make Time (DAT,CLK,RST)	t_{BBM}	R_L $_L$ = 35 pF V_{SW1} = V_{SW2} = 1.5 V Figure 15	T_A = +25°C	2	15		ns
			T_A = T_{MIN} to T_{MAX}	2			
Charge Injection	Q	C_L = 50 pF, R_{GEN} $_{GEN}$ = 0 V			100		pC
On-Channel Bandwidth -3dB (DAT,CLK,RST)	BW	R_L $_L$ = 5 pF Figure 16			100		MHz
Off-Isolation (DAT,CLK,RST)	V_{ISO}	R_L 0KHz Figure 17			-66		dB
Crosstalk	V_{CT}	R_L 0KHz Figure 18			-86		dB
RST, CLK, DAT Off Capacitance	C_{OFF}	V_{CC} = 3.3 V, Figure 19			30		pF
RST, CLK, DAT On Capacitance	C_{ON}	V_{CC} = 3.3 V, f = 1 MHz Figure 20			100		pF

Note 2: Devices are 100% tested at TA = +25℃. Limits across the full temperature range are guaranteed by design and correlation.

Test Diagrams /Timing Diagrams
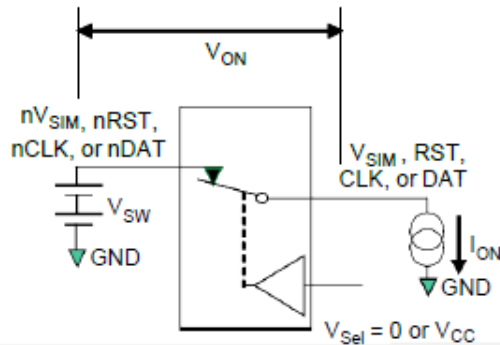
$$R_{ON} = V_{ON} / I_{ON}$$

Figure 9. On Resistance

$V_{Sel} = 0$ or V_{CC}

Figure 10. Off Leakage
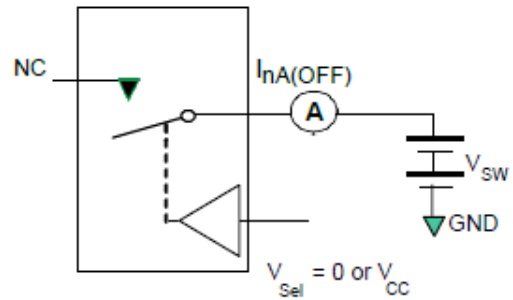
R and C$_L$ are functions of the application environment (see tables for specific values). C$_L$ includes test fixture and stray capacitance.
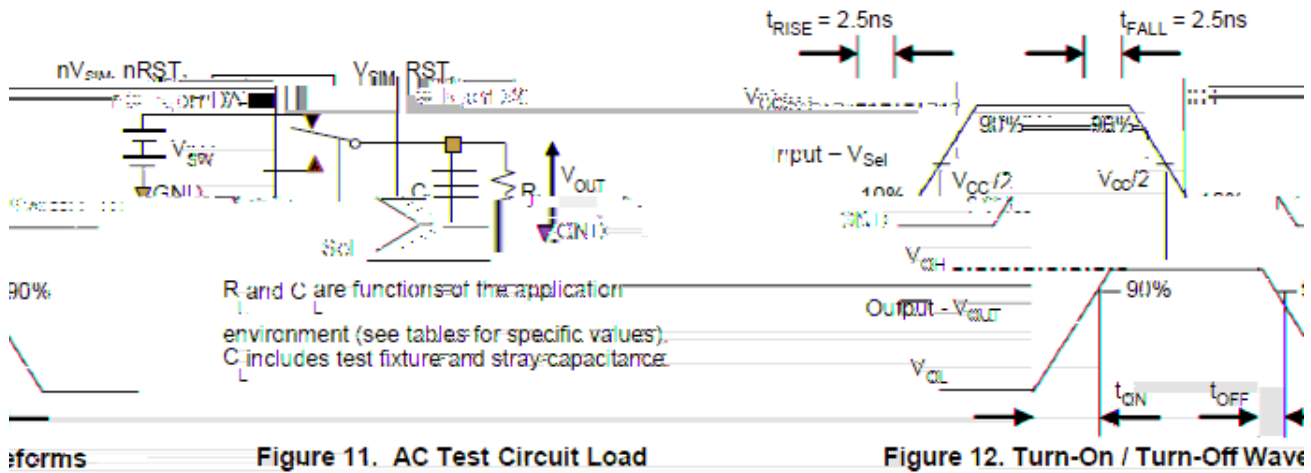
Figure 11. AC Test Circuit Load
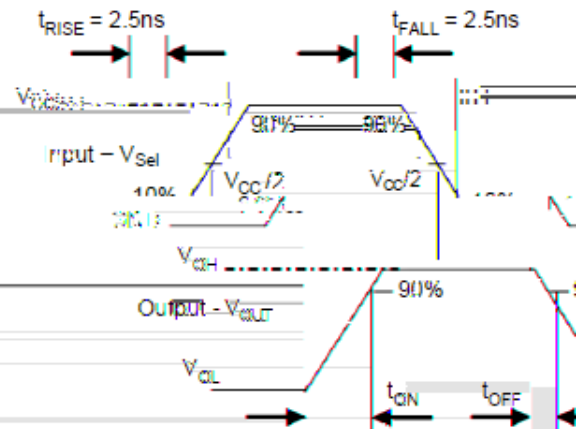
Figure 12. Turn-On / Turn-Off Wave
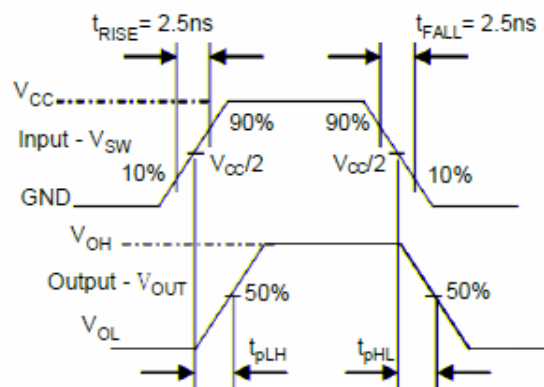
Figure 13. Propagation Delay

Test Diagrams /Timing Diagrams
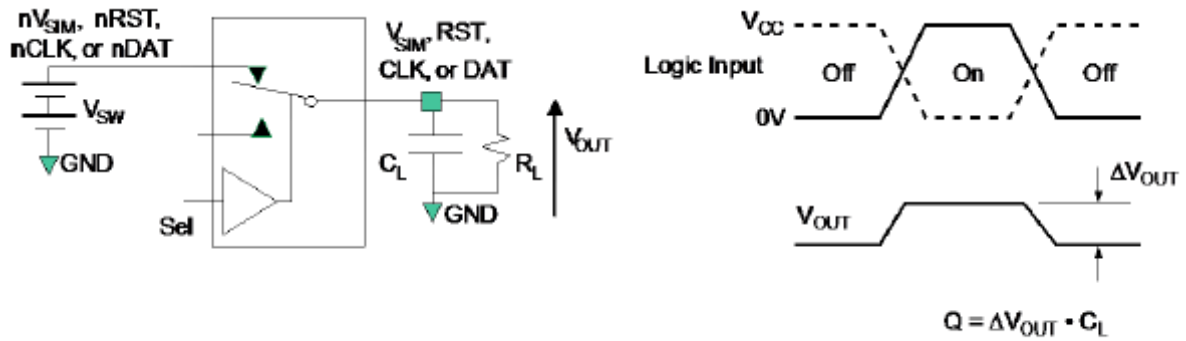
Figure 14. Charge Injection

$$Q = \Delta V_{OUT} \cdot C_L$$
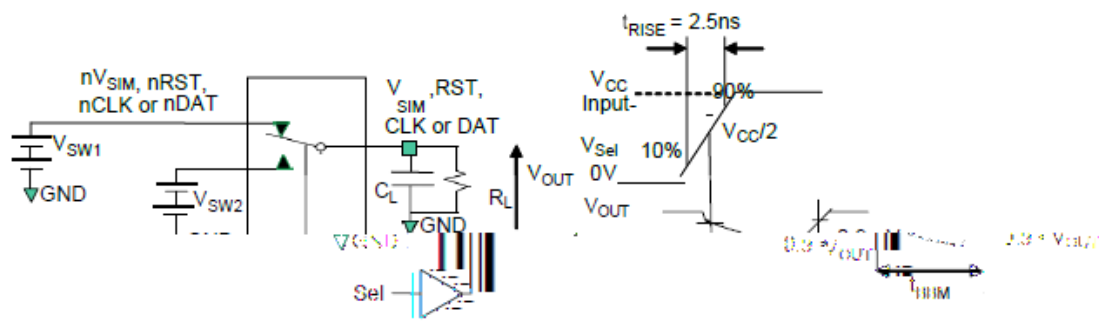
R_L and C_L are functions of the application environment (see tables for specific values).

Figure 15. Break-Before-Make Interval Timing

R_S and R_T are functions of the application
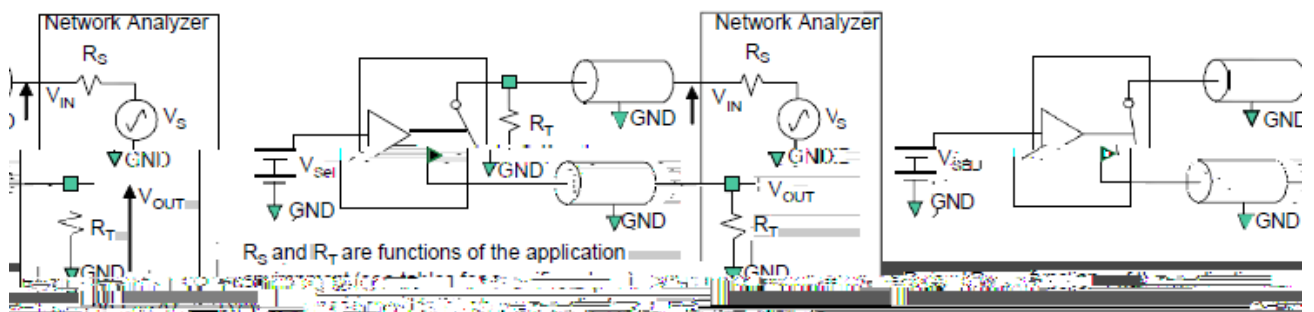
Figure 16. Bandwidth   **Figure 17. Channel Off Isolation**

Test Diagrams /Timing Diagrams

Figure 18. On-Adjacent Channel RC Switch Crosstalk
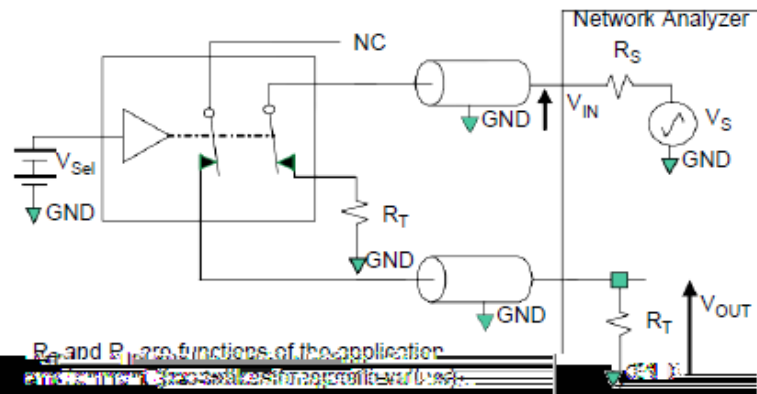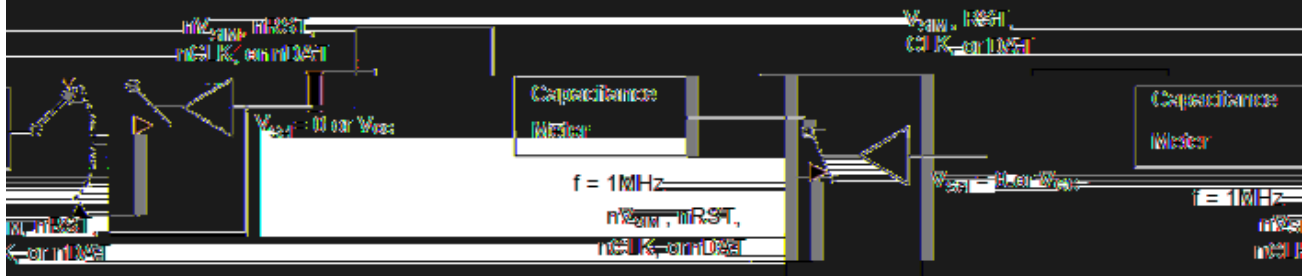
Figure 20. Channel-Off Capacitance

Figure 19. Channel-On Capacitance

Typical Operating Characteristics

(VCC = 3V, TA = +25°C, unless otherwise noted.)

ON-RESISTANCE vs. COM_ VOLTAGE
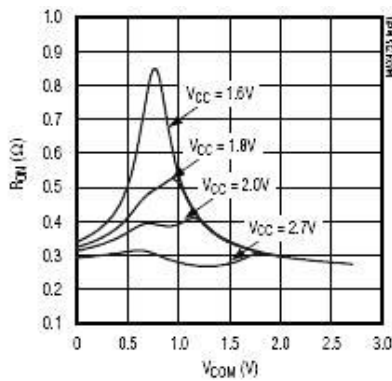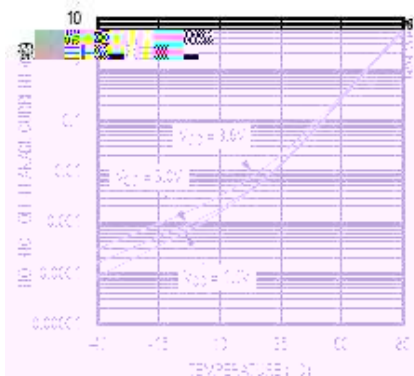

ON-RESISTANCE vs. COM_ VOLTAGE
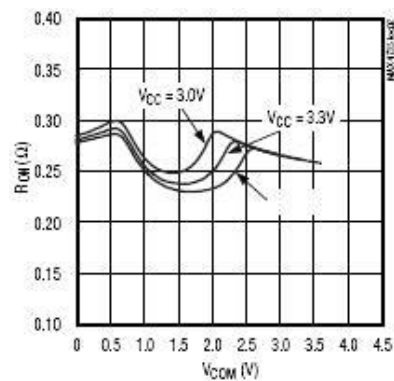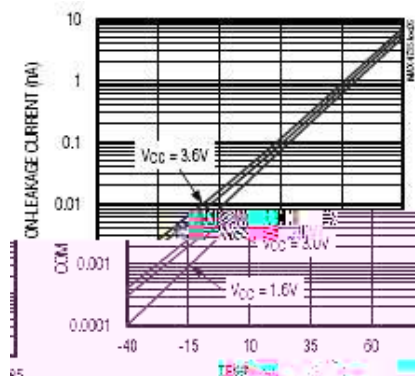

ON-RESISTANCE vs. COM_ VOLTAGE AND
TEMPERATURE
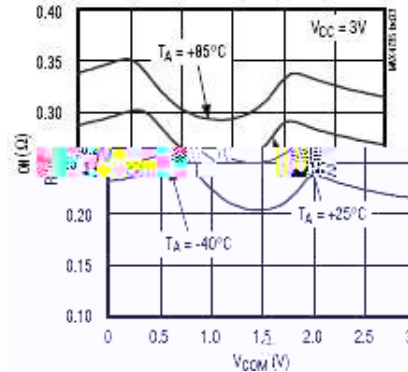
SUPPLY CURRENT vs. TEMPERATURE
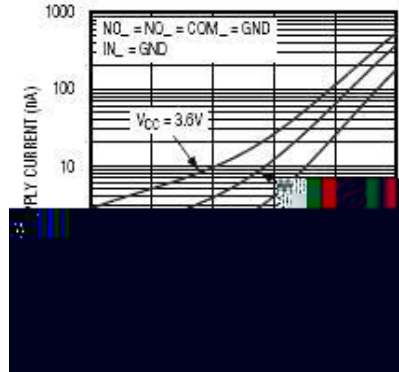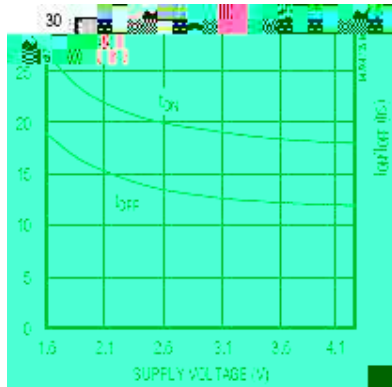

NO /NC OFF-LEAKAGE CURRENT vs.
TEMPERATURE
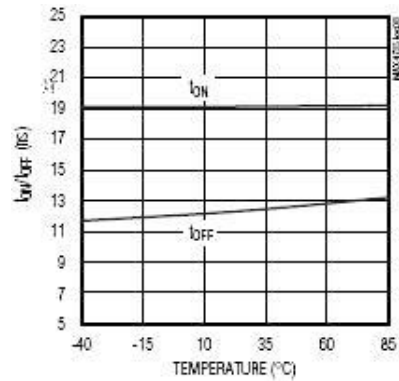

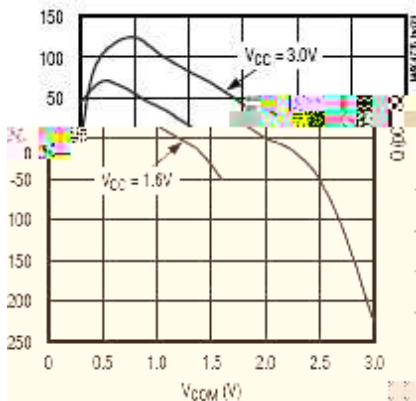COM ON-LEAKAGE CURRENT vs.
TEMPERATURE
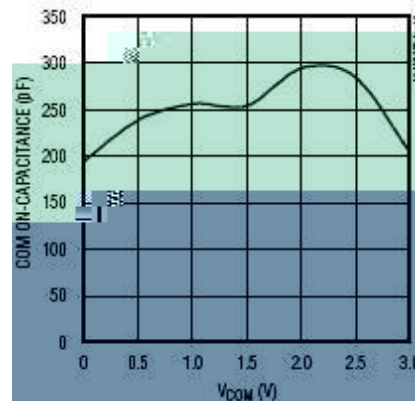
TURN-ON/OFF TIME vs. SUPPLY VOLTAGE
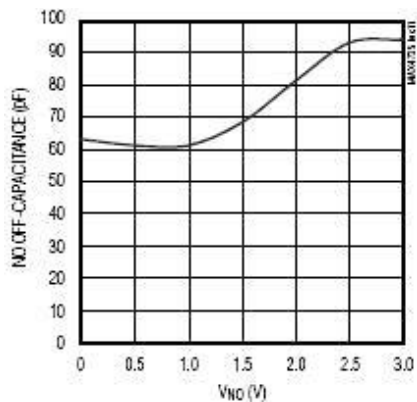

TURN-ON/OFF TIME vs. TEMPERATURE

CHARGE INJECTION vs. COM_ VOLTAGE

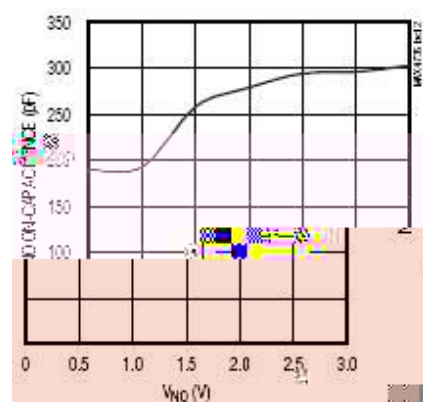
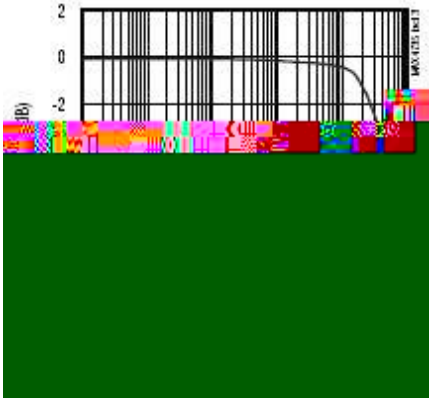COM_ ON-CAPACITANCE vs. COM_ VOLTAGE

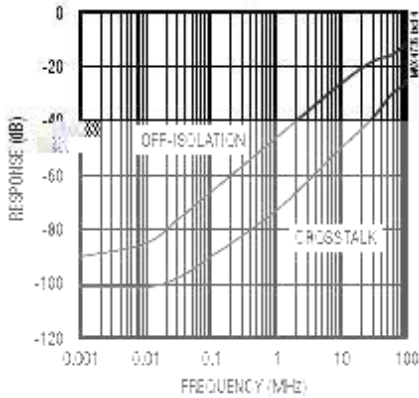NO_ OFF-CAPACITANCE vs. NO_ VOLTAGE

NO_ ON-CAPACITANCE vs. NO_ VOLTAGE

ON-RESPONSE vs. FREQUENCY

OFF-ISOLATION AND CROSSTALK vs. FREQUENCY

PACKAGE OUTLINE DIMENSIONS: TQFN 3x3 -16L

PIN 1 DOT
BY MARKING

D

E

TOP VIEW

D2

E2

PIN #1 IDENTIFICATION
CHAMFER

b

e

L

BOTTOM VIEW

A

A1

A3

SIDE VIEW
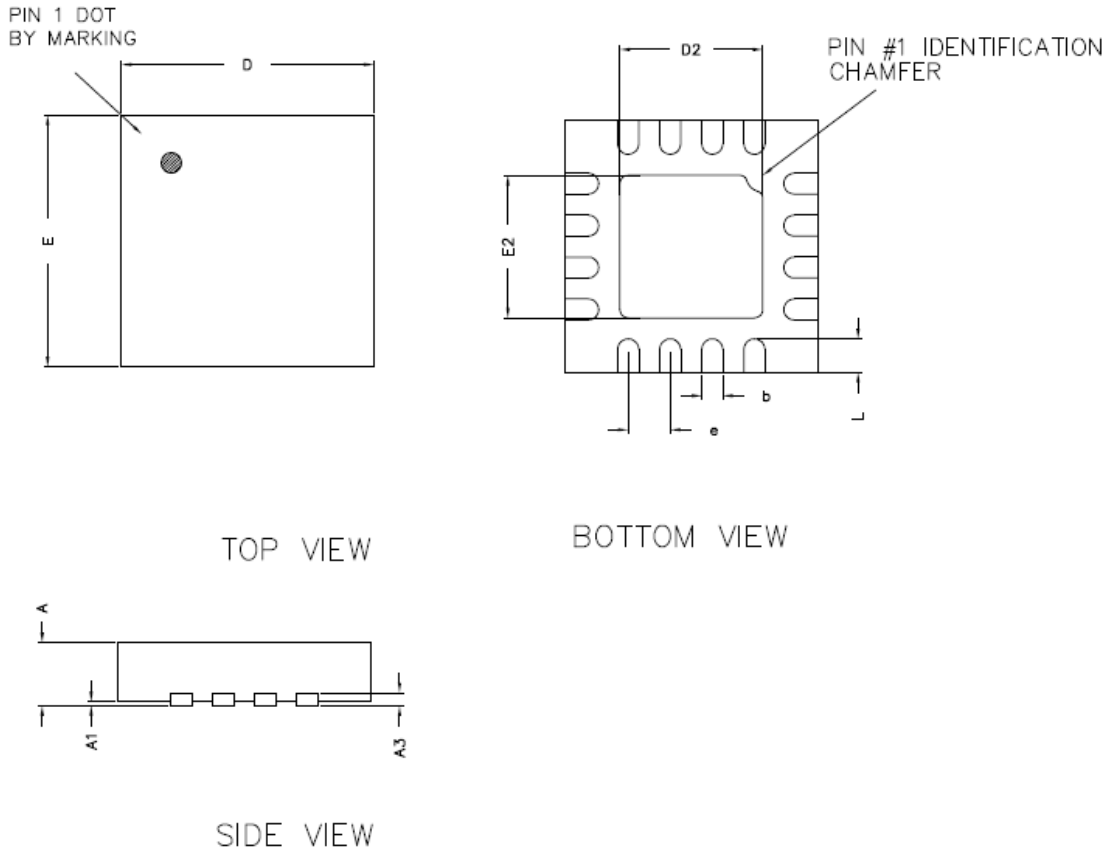
COMMON DIMENSIONS(MM)			
PKG.	W: VERY VERY THIN		
REF.	MIN.	NOM.	MAX
A	0.70	0.75	0.80
A1	0.00	–	0.05
A3	0.2 REF.		
D	2.95	3.00	3.05
E	2.95	3.00	3.05
b	0.18	0.25	0.30
L	0.30	0.40	0.50
D2	1.55	1.70	1.80
E2	1.55	1.70	1.80
e	0.5 BSC		

PACKAGE OUTLINE DIMENSIONS: UTQFN 1.8x2.6 -16L

TOP VIEW

BOTTOM VIEW

SIDE VIEW
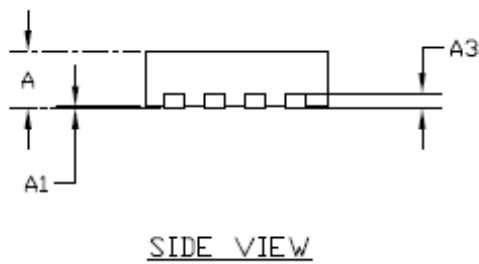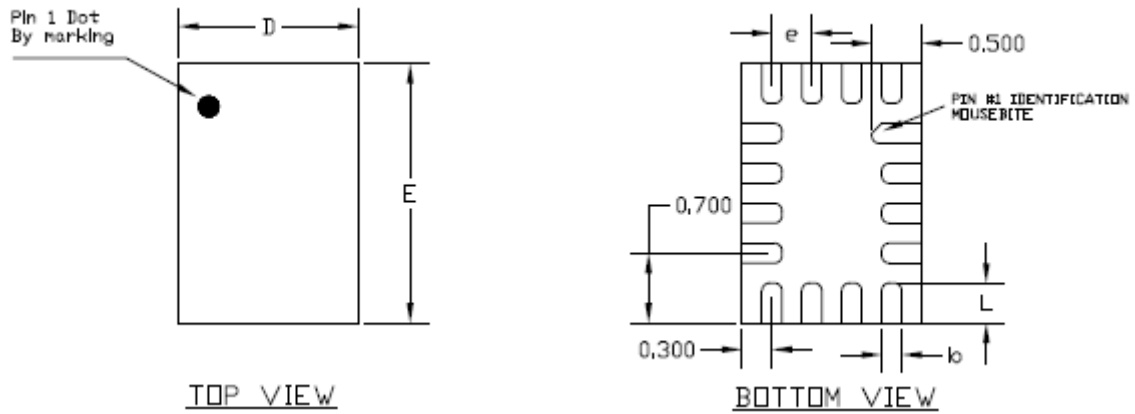
COMMON DIMENSIONS(MM)			
PKG.	UT:ULTRA THIN		
REF.	MIN.	NOM.	MAX
A	>0.50	0.55	0.60
A1	0.00	–	0.05
A3	0.15 REF.		
D	1.75	1.80	1.85
E	2.55	2.60	2.65
L	0.30	0.40	0.50
b	0.15	0.20	0.25
e	0.40 BSC		